



SPN60T15 N-Channel Enhancement Mode MOSFET

DESCRIPTION

The SPN60T15 is the N-Channel enhancement mode power field effect transistor which is produced using super high cell density DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suitable for synchronous rectifier application, Motor control power management and other Power Tool circuits. It has been optimized for low gate charge, low $R_{DS(ON)}$ and fast switching speed.

FEATURES

- ◆ 150V/60A, $R_{DS(ON)}=19m\Omega@V_{GS}=10V$
- ◆ High density cell design for extremely low $R_{DS(ON)}$
- ◆ Exceptional on-resistance and maximum DC current capability
- ◆ TO-220-3L/TO-220F-3L/PPAK5x6-8L package design

APPLICATIONS

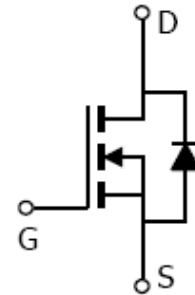
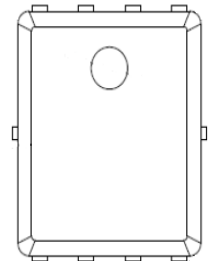
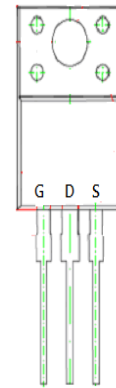
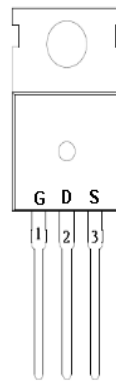
- AC/DC Synchronous Rectifier
- Load Switch
- UPS
- Power Tool
- Motor Control

PIN CONFIGURATION

TO-220

TO-220F

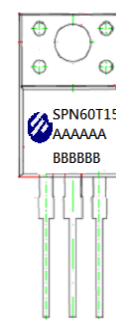
PPAK5x6



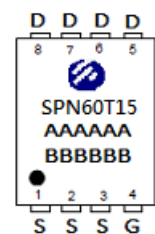
PART MARKING



A : Lot Code
B : Date Code
(YY/MM/DD)



A: Lot Code
B: Date Code
(YYMMDD)



A : Lot Code
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(YY/MM/DD)



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TO-220/TO-220F PIN DESCRIPTION

Pin	Symbol	Description
1	G	Gate
2	D	Drain
3	S	Source

PPAK5x6 PIN DESCRIPTION

Pin	Symbol	Description
1	S	Source
2	S	Source
3	S	Source
4	G	Gate
5	D	Drain
6	D	Drain
7	D	Drain
8	D	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking
SPN60T15T220TGB	TO-220-3L	SPN60T15
SPN60T15T220FTGB	TO-220F-3L	SPN60T15
SPN60T15DN8RGB	PPAK5x6-8L	SPN60T15

- ※ SPN60T15T220TGB : Tube ; Pb – Free ; Halogen – Free
- ※ SPN60T15T220FTGB : Tube ; Pb – Free ; Halogen - Free
- ※ SPN60T15DN8RGB : Tape&Reel ; Pb – Free ; Halogen - Free



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ABSOLUTE MAXIMUM RATINGS

(T_j=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit	
Drain-Source Voltage	V _{DSS}	150	V	
Gate –Source Voltage	V _{GSS}	±20	V	
Continuous Drain Current	I _D	T _C =25°C	69	A
		T _C =100°C	49	
Pulsed Drain Current(TO-220/TO-220F)	I _{DM}	150	A	
Pulsed Drain Current(PPAK5x6)		120		
Avalanche Energy, Single Pulse @ L=0.3mH, T _C =25°C	E _{AS}	184	mJ	
Power Dissipation @ T _C =25°C (TO-220/TO-220F)	P _D	214	W	
Power Dissipation @ T _C =25°C (PPAK5x6)		125		
Operating Junction Temperature	T _J	-55/150	°C	
Storage Temperature Range	T _{STG}	-55/150	°C	
Continuous Body-Diode Forward Current	I _S	T _C =25°C	69	A
		T _C =100°C	49	
Thermal Resistance-Junction to Ambient (TO-220/TO-220F)	R _{θJA}	60	°C/W	
Thermal Resistance-Junction to Ambient (PPAK5x6)	R _{θJA}	50	°C/W	
Thermal Resistance-Junction to Case (TO-220/TO-220F)	R _{θJC}	0.7	°C/W	
Thermal Resistance-Junction to Case (PPAK5x6)	R _{θJC}	1	°C/W	



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ELECTRICAL CHARACTERISTICS

(TA=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	150			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2.0	3.0	4.0	
Gate Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=150V, V_{GS}=0V$ $T_J=25^\circ C$			1	uA
		$V_{DS}=150V, V_{GS}=0V$ $T_J=100^\circ C$			100	
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=20A$		15	19	mΩ
Forward Transconductance	g_{fs}	$V_{DS}=5V, I_D=20A$		50		S
Gate Resistance	R_G	$V_{GS}=0V, V_{DS}=\text{Open}, f=1\text{MHz}$		3.5		Ω
Diode Forward Voltage	V_{SD}	$I_S=20A, V_{GS}=0V$		0.9	1.2	V
Dynamic						
Total Gate Charge	Q_g	$V_{DS}=75V, V_{GS}=10V$ $I_D=20A$		27		nC
Gate-Source Charge	Q_{gs}			9		
Gate-Drain Charge	Q_{gd}			2		
Input Capacitance	C_{iss}	$V_{DS}=75V, V_{GS}=0V$ $f=1\text{MHz}$		2275		pF
Output Capacitance	C_{oss}			165		
Reverse Transfer Capacitance	C_{rss}			5.5		
Turn-On Time	$t_{d(on)}$	$V_{DD}=75V, V_{GS}=10V$ $I_D=20A, R_G=10\Omega$		12		nS
	t_r			4		
Turn-Off Time	$t_{d(off)}$			24		
	t_f			5		
Reverse Recovery Time	t_{rr}		$V_R=75V, I_F=20A,$ $dI_F/dt=100A/\mu S$		90	
Reverse Recovery Charge	Q_{rr}			234		nC



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TYPICAL CHARACTERISTICS

Fig 1. Typical Output Characteristics

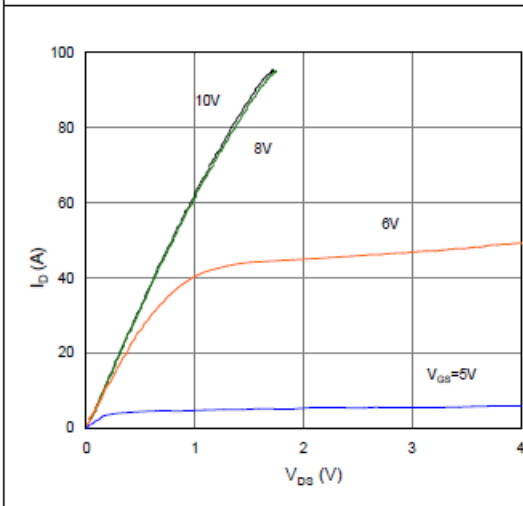


Figure 2. On-Resistance vs. Gate-Source Voltage

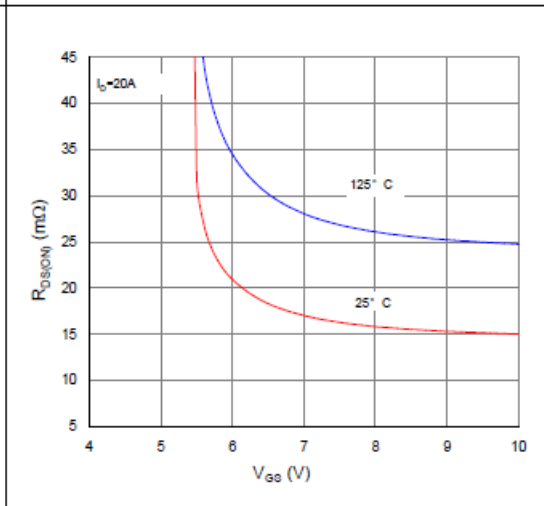


Figure 3. On-Resistance vs. Drain Current and Gate Voltage

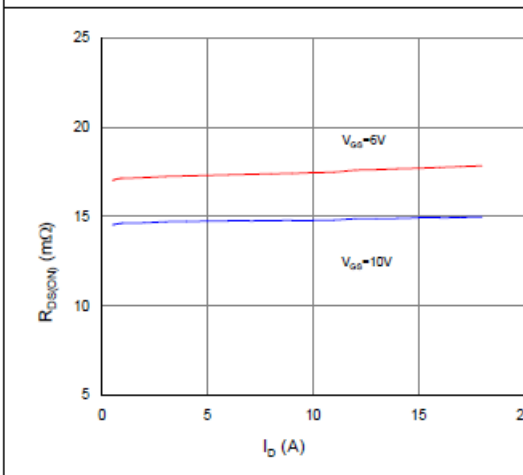


Figure 4. Normalized On-Resistance vs. Junction Temperature

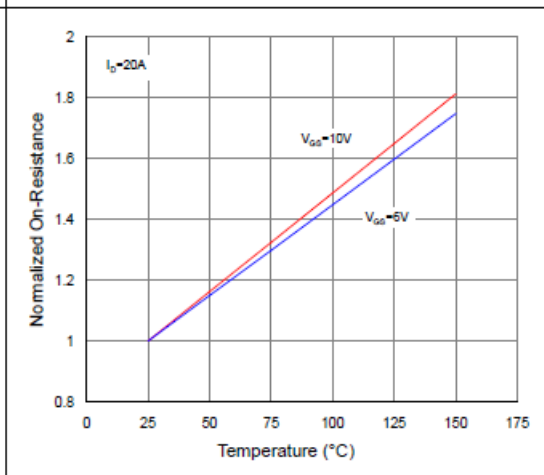


Figure 5. Typical Transfer Characteristics

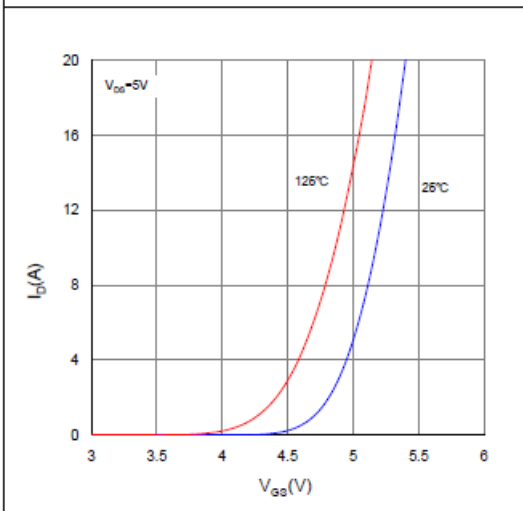
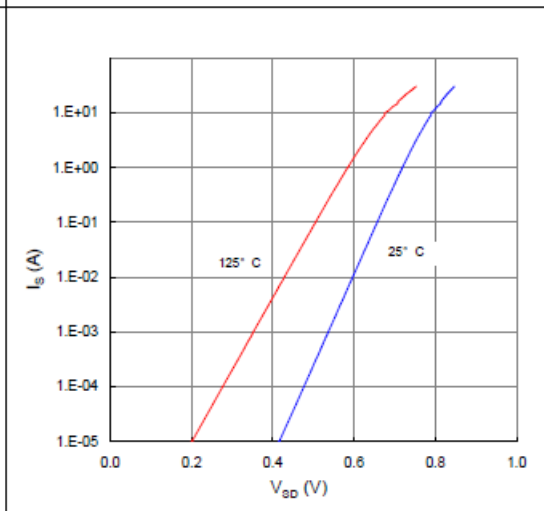


Figure 6. Typical Source-Drain Diode Forward Voltage





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TYPICAL CHARACTERISTICS

Figure 7. Typical Gate-Charge vs. Gate-to-Source Voltage

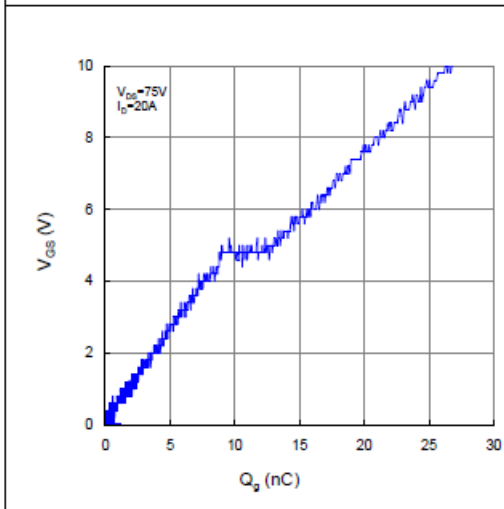


Figure 8. Typical Capacitance vs. Drain-to-Source Voltage

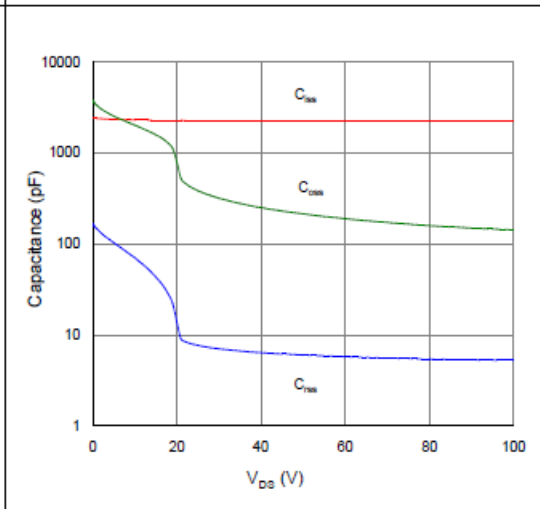


Figure 9. Maximum Safe Operating Area

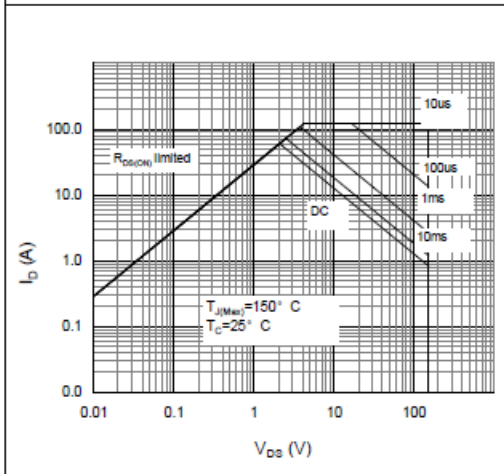


Figure 10. Maximum Drain Current vs. Case Temperature

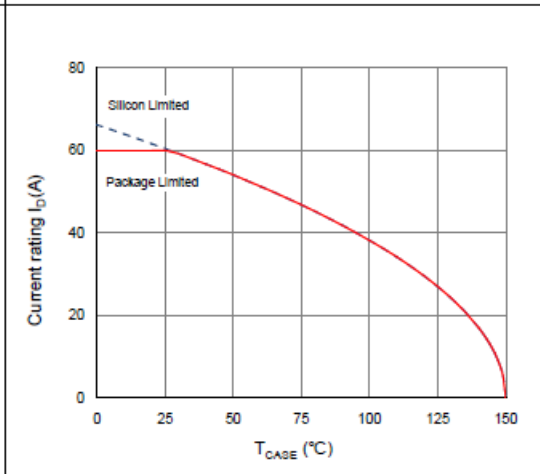
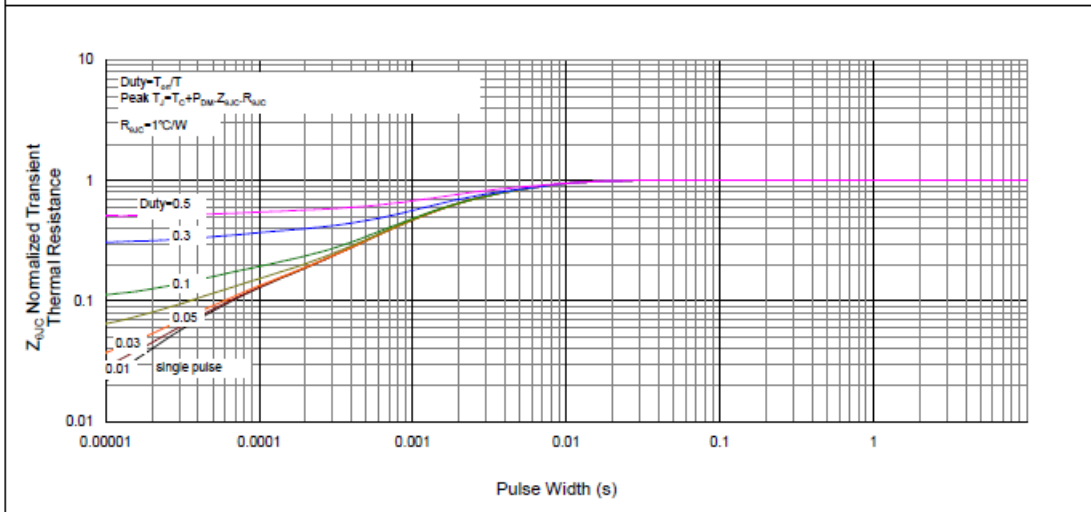


Figure 11. Normalized Maximum Transient Thermal Impedance, Junction-to-Case





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